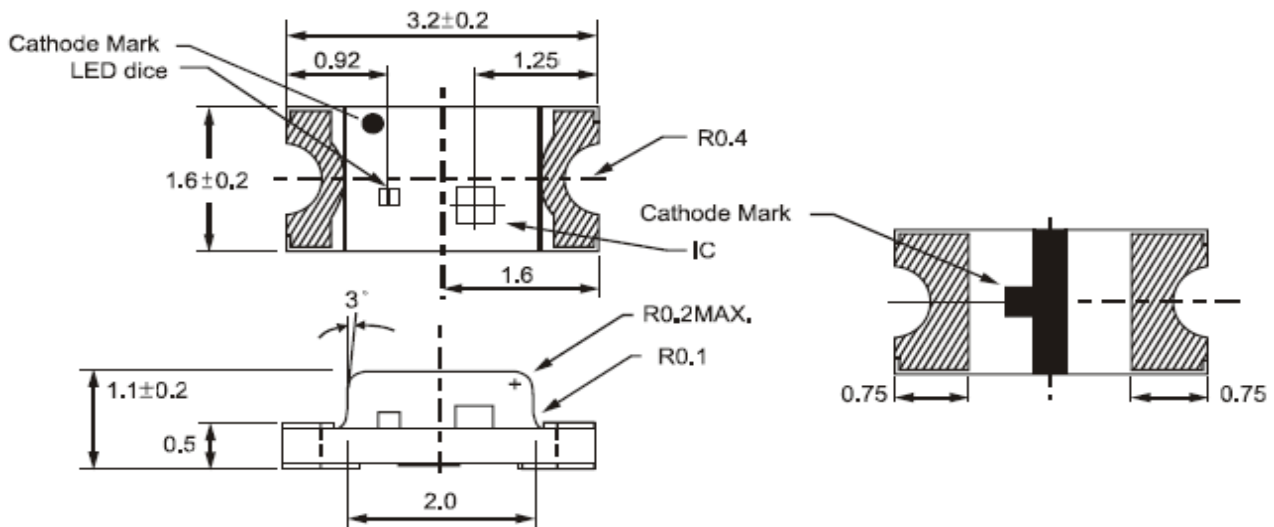




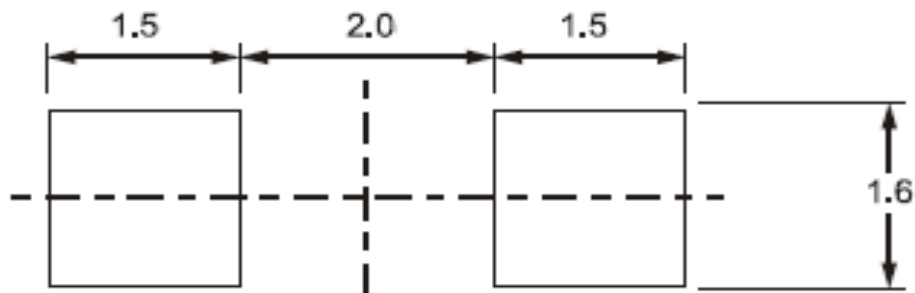
**Applications**

- Interior automotive lighting
- Optical indicators
- Communication Products
- Backlighting
- Toys

**Technical Drawing**



**Recommended Soldering Pattern**



**Notes :**

All dimensions in mm tolerance is  $\pm 0.1\text{mm}$  unless otherwise noted.

<b>SMT Blinking Chip LED Yellow Green</b>	
Part No.:	<b>M11N6002</b>
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**Absolute Maximum Ratings**

Ta=25°C

Item	Symbol	GaP	Unit
Power Dissipation	P <sub>D</sub>	---	mW
DC Forward Current	I <sub>F</sub>	12	mA
Pulsed Forward Current	I <sub>FP</sub> *	100	mA
Reverse Voltage	V <sub>R</sub>	5	V
Operating Temperature	T <sub>OP</sub>	-25 to 80	°C
Storage Temperature	T <sub>ST</sub>	-20 to 85	°C

\* 0.1 msec pulse, 10% duty cycle

**Electrical / Optical Characteristics**

Ta=25°C

Ermitting Color	Yellow Green		
Material	GaP		
Forward Current	typ.	20	A
	max.	---	A
Wavelength typ.	λP	568	nm
	Δλ	---	nm
Color Temperature	min.	---	K
	max.	---	K
Luminous Intensity *	min.	8.2	mcd
	typ.	25	mcd
Pulse Rate VDD = 5V	min.	2.0	Hz
	typ.	2.4	Hz
	max.	3.0	Hz
Reverse Current	max.	---	μA
Viewing Angle	2Θ1/2	120	

\* Per NIST standards

**SMT Blinking Chip LED**  
**Yellow Green**

Part No.: **M11N6002**

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**Directive Characteristics**

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Curvs

**SMT Blinking Chip LED  
Yellow Green**

Part No.: **M11N6002**

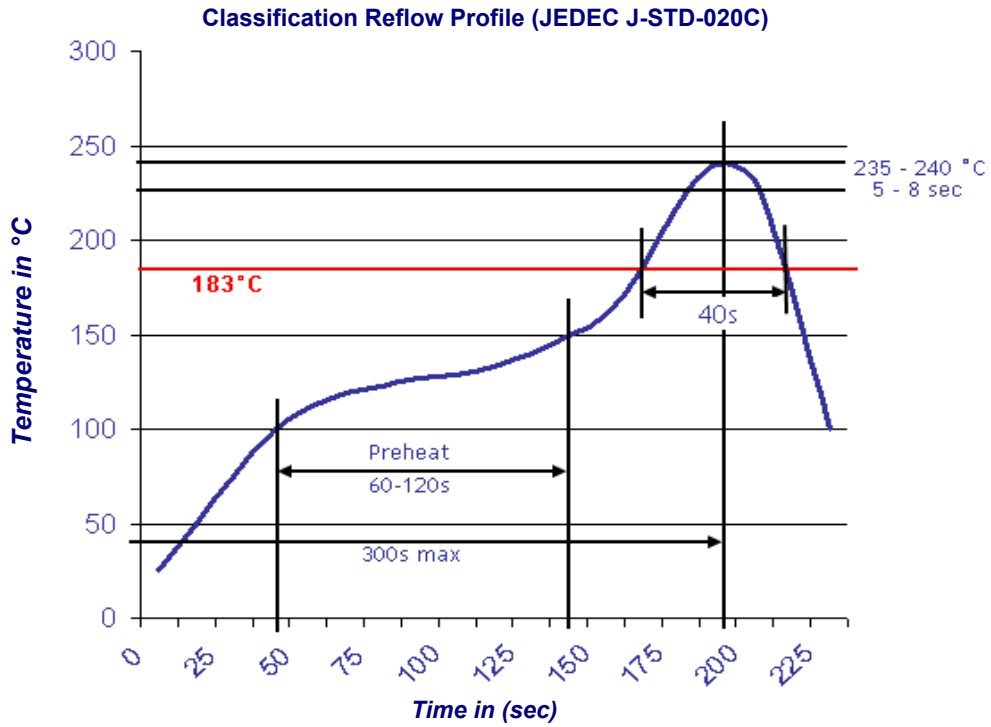
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**Solder Condition**

**Lead Free Solder**



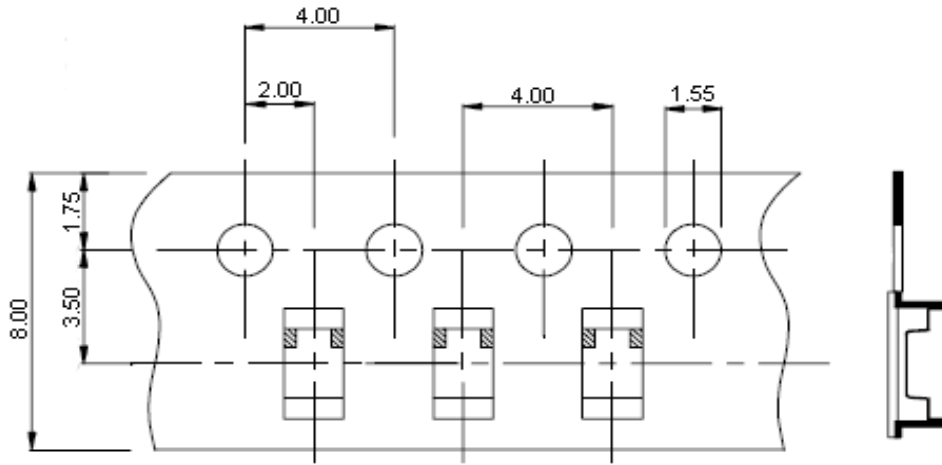
<b>SMT Blinking Chip LED Yellow Green</b>	
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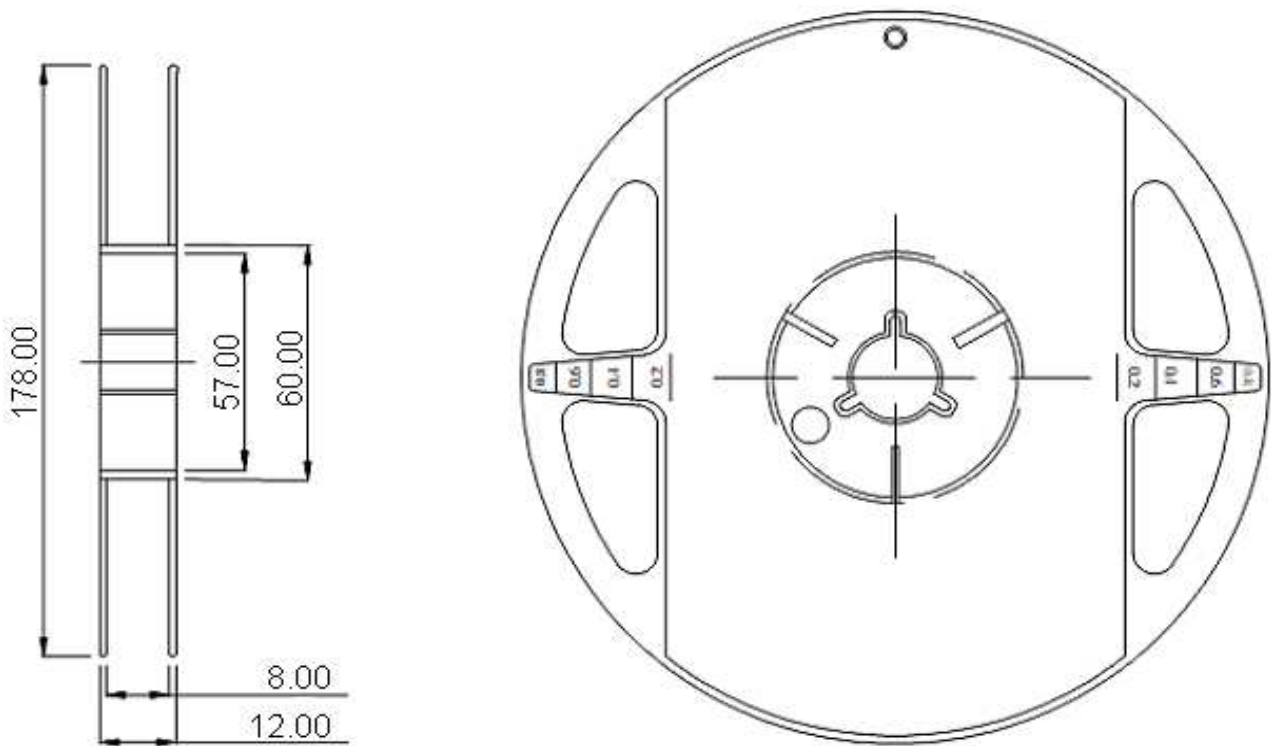
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**Packing Specifications**



**Reel Specifications**



**SMT Blinking Chip LED**  
**Yellow Green**

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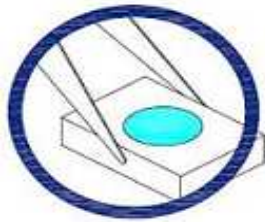
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**Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.

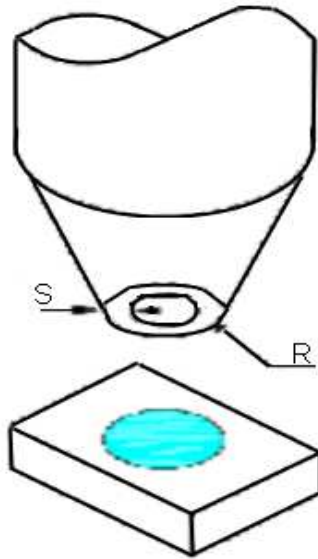


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4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



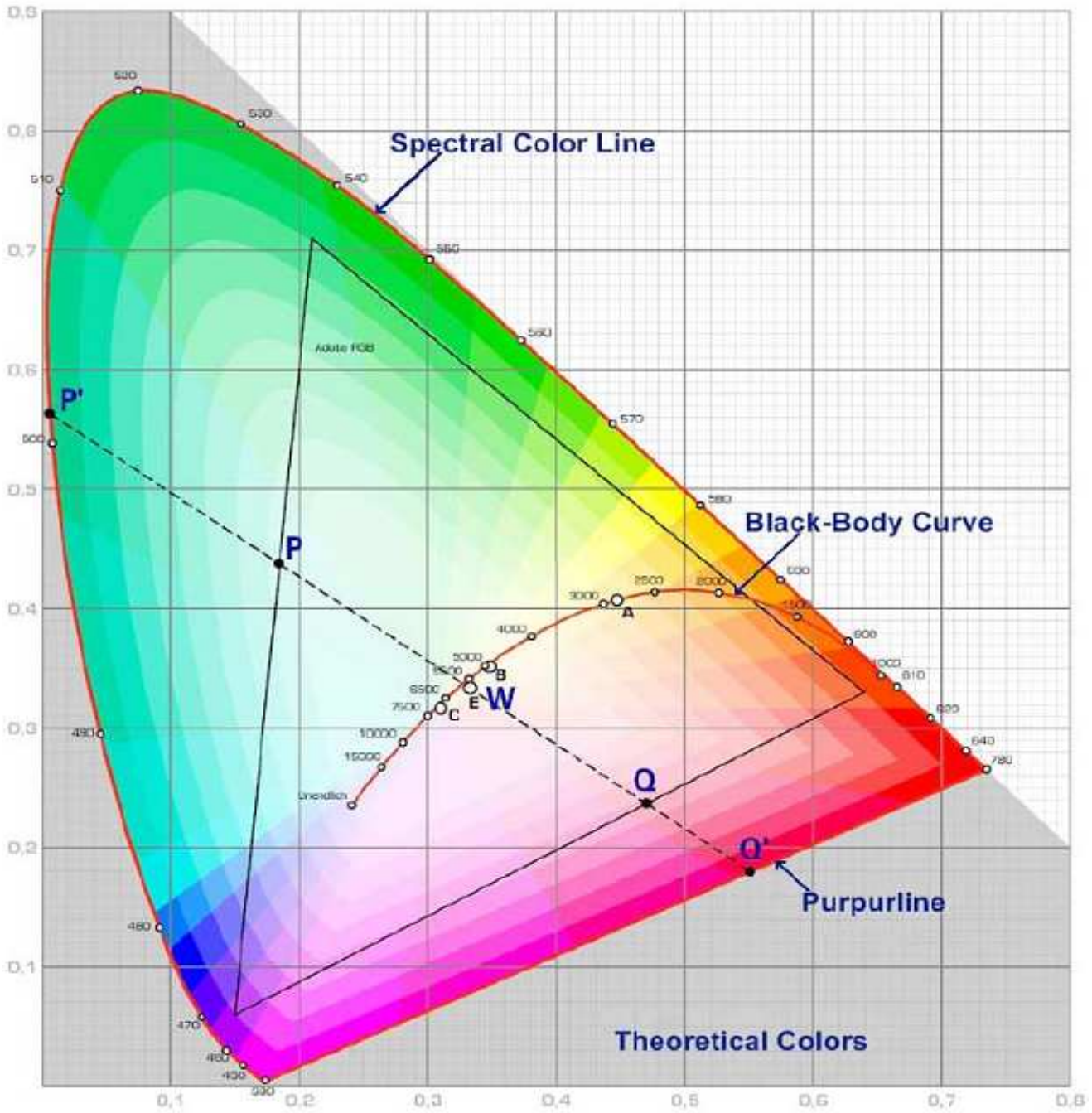
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**Color table curve**



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